

INDUSTRIAL COMPONENT DATA

MSTBA 2,5/10-G-5,08 BU 1521146 PHOENIX CONTACT Printed circuit board base case, nominal section: 2.5 mm², co..

Brand: PHOENIX CONTACT | Manufacturer Part Number: MSTBA 2,5/10-G-5,08 BU



Manufacturer	PHOENIX CONTACT
MPN / Reference	MSTBA 2,5/10-G-5,08 BU
Catalog number	1521146
Category	Printed circuit board connector
Minimum order	1000 Pcs
Document ID	EO-1ED104F915
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Product Overview

Printed circuit board base case, nominal section: 2.5 mm², color: blue, nominal current: 12 A, nominal voltage (III/2): 320 V, contact surface: Sn, contact connection type: Male, number of rows: 1, number of poles: 10, article family: MSTBA 2.5/.. -G, pitch: 5.08 mm, mounting: Wave soldering, pin arrangement: Linear pin arrangement, pin length [P]: 3.23 mm, number of solder pins per potential: 1, plug-in system: COMBICON MSTB 2.5, Plug-in face orientation: Standard, locking: without, fixing type: without, packaging type: boxed

STRUCTURED PRODUCT DATA

Technical Specifications

No structured technical attributes are currently available. Submit an RFQ for technical review.

Classification & Catalog Path

Catalog path PHOENIX CONTACT > PCB Connectors (PCC)

Additional Product Information

Technical dataItem PropertiesProduct Line COMBICON Connectors M

Product Type Printed circuit board base housing

Product Family MSTBA 2.5/.. -G

Number of poles 10

Step 5.08 mm

Number of rows 1

Pin Design Linear Pin Arrangement

Number of Solder Pins Per Potential 1

Electrical PropertiesNominal Current IN 12 A

Nominal voltage UN 320 V

Degree of pollution 3

Contact resistance 1.4 m?
Sizing voltage (III/3) 320 V
Dimensioning transient voltage (III/3) 4 kV
Dimensioning voltage (III/2) 320 V
Dimensioning Transient Voltage (III/2) 4 kV
Nominal voltage (II/2) 630 V
Dimensioning transient voltage (II/2) 4 kV
assemblyType of mounting Wave soldering
Pin Design Linear Pin Arrangement
Material DataMaterial data - contact
Observation WEEE/RoHS compliant, filament-free according to IEC 60068-2-82/JEDEC JESD 201
Contact material Cu Alloy
Surface Characteristics Galvanically tinned
Metal surface contact area (top layer) Tin (3 - 5 um Sn)
Metal Surface Contact Area (Middle Layer) Nickel (1.3 - 3 um Ni)
Metal surface weld area (top layer) Tin (3 - 5 um Sn)
Metal Surface Welding Area (Middle Layer) Nickel (1.3 - 3 um Ni)
Material data - housing
Color (Housing) Blue (5015)
Insulating material PA
Insulating material group I
CTI according to IEC 60112 600
Flammability class according to UL 94 V0
Flammability number of GWFI incandescent filaments according to EN 60695-2-12 850
Ignition temperature of incandescent filaments GWIT according to EN 60695-2-13 775
Ball hardness test temperature according....

REQUEST PRICE, AVAILABILITY & TECHNICAL REVIEW

Send PHOENIX CONTACT / MSTBA 2,5/10-G-5,08 BU with the required quantity to info@electricaonline.com or use electricaonline.com/request-quote.

GLOBAL OFFICES

Germany: Lise-Meitner-Straße 13, 89081 Ulm | USA: 16225 Park Ten Pl #500, Houston, TX 77084 | UAE: HDS Business Centre Tower, Cluster M, 33rd Floor, JLT, Dubai

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